

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	50	V
Collector-Emitter Voltage	V _{CEO}	45	V
Emitter-Base Voltage	V _{EBO}	6.0	V
Continuous Collector Current	Ic	100	mA
Peak Pulse Collector Current	I _{CM}	200	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

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Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	435	mW
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	287	°C/W
Thermal Resistance, Junction to Lead (Note 8)	R _{θJL}	150	°C/W
Operating and Storage and Temperature Range	TJ, TSTG	-55 to +150	°C

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge – Machine Model	ESD MM	200	V	В

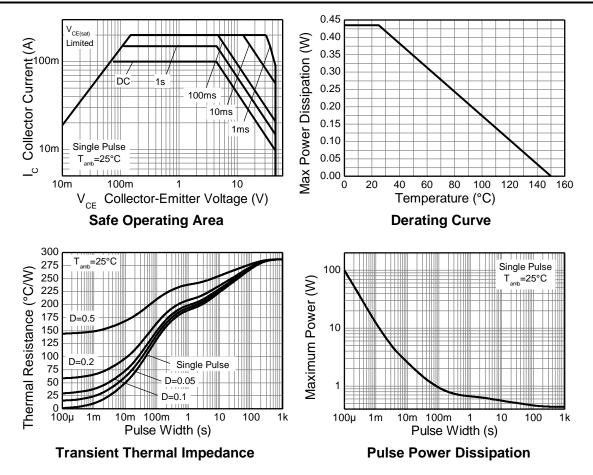
Notes: 6. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.

Thermal resistance from junction to solder-point (on the exposed collector pad).

8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





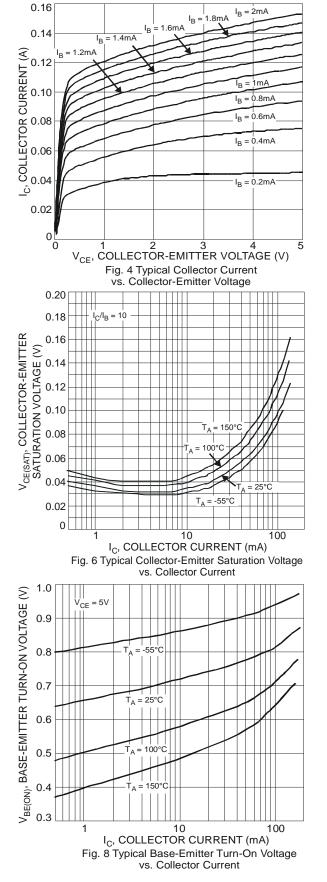
Electrical Characteristics	(@T _A = +25°C, unless otherwise specified.)
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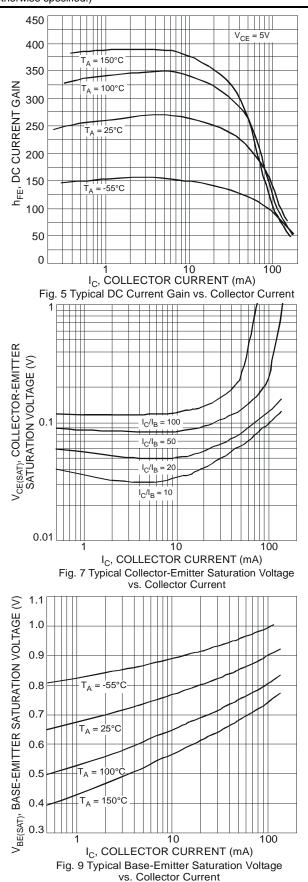
Characteristic	Symbol	Min	Typical	Мах	Unit	Test Condition
DFF CHARACTERISTICS						Test condition
Collector-Base Breakdown Voltage	BV _{CBO}	50	150		V	$I_{\rm C} = 50 \mu A, I_{\rm B} = 0$
Collector-Emitter Breakdown Voltage	BV _{CES}	50	150	_		$I_{\rm C} = 50 \mu A, I_{\rm B} = 0$
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	45	65	_	V	$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$
Collector-Base Breakdown Voltage	BVEBO	6.0	8.35	_	V	$I_{E} = 50 \mu A, I_{C} = 0$
Collector-Base Cutoff Current	I _{CBO}		—	15	nA	$V_{CB} = 40V$
Collector-Emitter Cutoff Current	ICES	_	_	15	nA	$V_{CE} = 40V$
ON CHARACTERISTICS (Note 9)				-		
DC Current Gain	h _{FE}	200	220 260	470	—	$I_{C} = 10\mu A, V_{CE} = 5.0V$ $I_{C} = 2.0mA, V_{CE} = 5.0V$
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		50 122	125 300	mV	$I_{C} = 10$ mA, $I_{B} = 0.5$ mA $I_{C} = 100$ mA, $I_{B} = 5.0$ mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	_	760 880	1,000 1,100	mV	$I_{C} = 10$ mA, $I_{B} = 0.5$ mA $I_{C} = 100$ mA, $I_{B} = 5.0$ mA
Base-Emitter Voltage	V _{BE(ON)}	580	650 725	750 800	mV	$I_{C} = 2.0 \text{mA}, V_{CE} = 5 \text{V}$ $I_{C} = 10 \text{mA}, V_{CE} = 5 \text{V}$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	Сово	_	1.5	_	pF	$V_{CB} = 10.0V, f = 1.0MHz, I_E = 0$
Current Gain-Bandwidth Product	f⊤	100	170	_	MHz	$V_{CE} = 5V$, $I_C = 10mA$, f = 100MHz

Note: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)



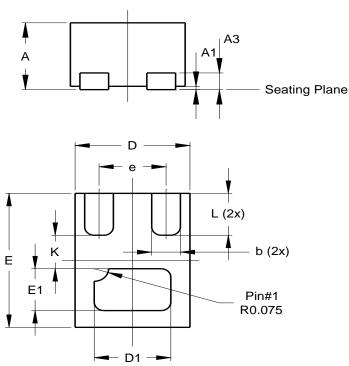


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Package Outline Dimensions

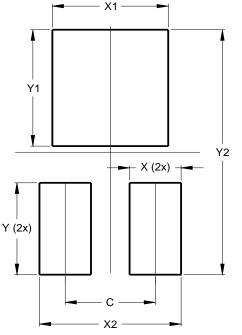
Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN0806-3					
Dim	Min	Max	Тур		
Α	0.375	0.40	0.39		
A1	0	0.05	0.02		
A3	_	-	0.10		
b	0.10	0.20	0.15		
D	0.55	0.65	0.60		
D1	0.35	0.45	0.40		
ш	0.75	0.85	0.80		
E1	0.20	0.30	0.25		
е	_	-	0.35		
К	_	-	0.20		
L	0.20	0.30	0.25		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.350
Х	0.200
X1	0.450
X2	0.550
Y	0.375
Y1	0.475
Y2	1.000

X2-DFN0806-3

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